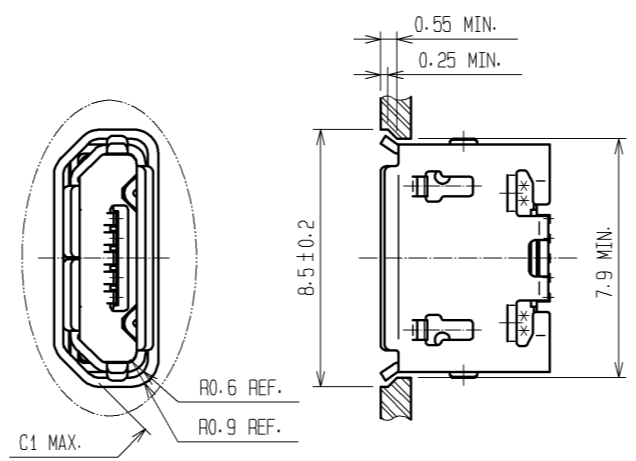
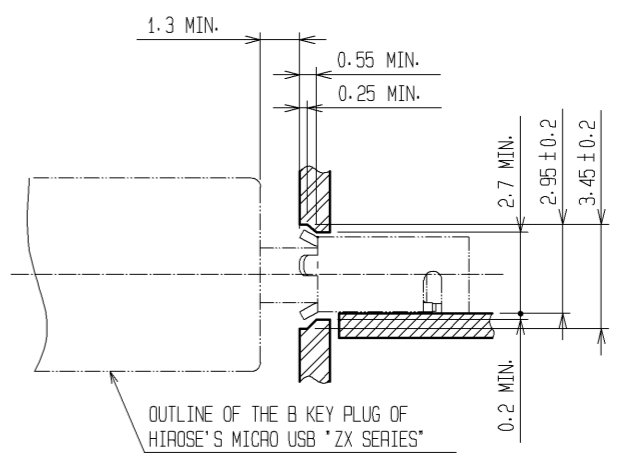


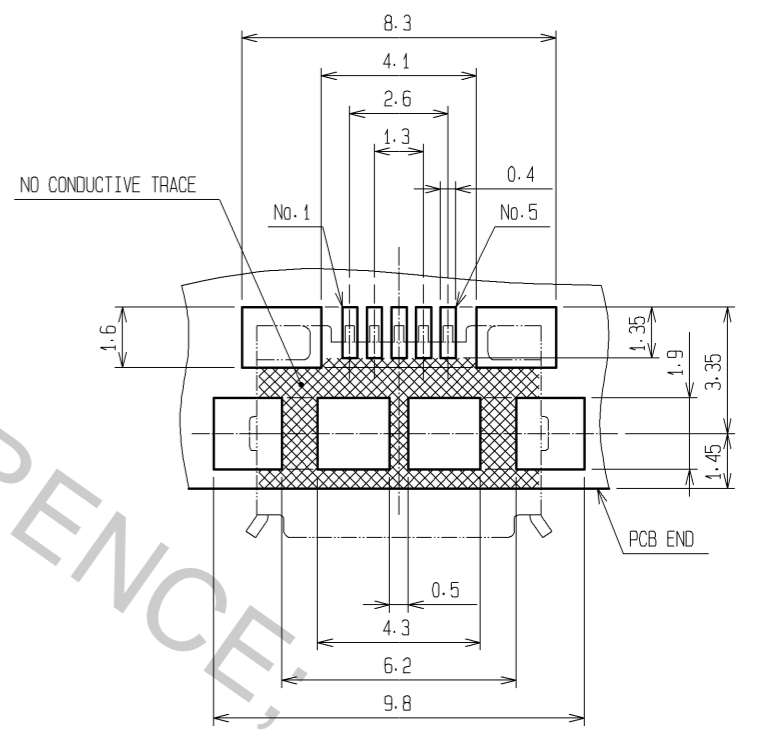
RECOMMENDED PANEL CUTOUT(4:1)



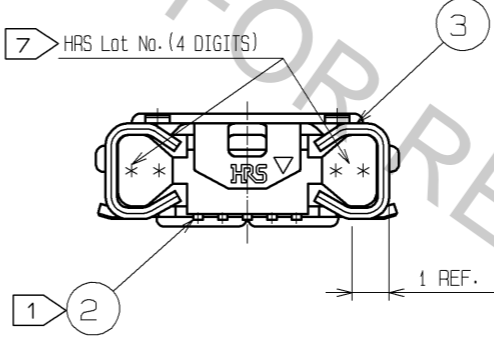
MATED WITH CORRESPONDING PLUG(4:1)



PCB LAYOUT

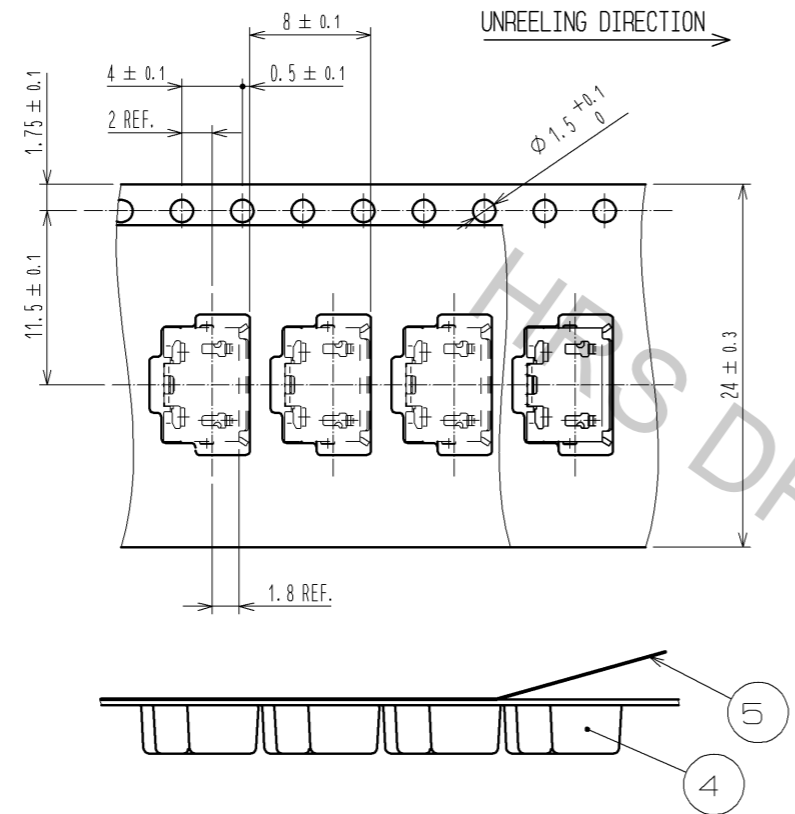


- NOTES
- 1 CO-PLANARITY IS WITHIN 0.08 mm.
  - 2 PLATING  
CONTACT AREA : GOLD 0.75µm MIN.  
LEAD AREA : GOLD 0.05µm MIN.  
UNDER PLATING: NICKEL 2µm MIN.
  - 3 PER REEL : 3500 pcs.
  - 4. INTERFACE DIMENSIONS CONFORM TO USB2.0 SPECIFICATION.
  - 5. AS FOR PART No.3, THE PERFORMANCE REMAINS GOOD EVEN IF THERE ARE RUBBING WOUNDS BY THE ASSEMBLY PROCESS. AND, THE PERFORMANCE REMAINS GOOD THOUGH THERE MIGHT BE A DIFFERENCE IN THE PLATING LUSTER BETWEEN EACH PLATING SUBCONTRACT COMPANIES.
  - 6. AS FOR PART No.1, A PART OF SHAPE MAY BECOME DIFFERENT DEPENDING ON THE PRODUCTION METHOD.
  - 7 CODE CONFIGURATION IS SHOWN IN FIG.1.



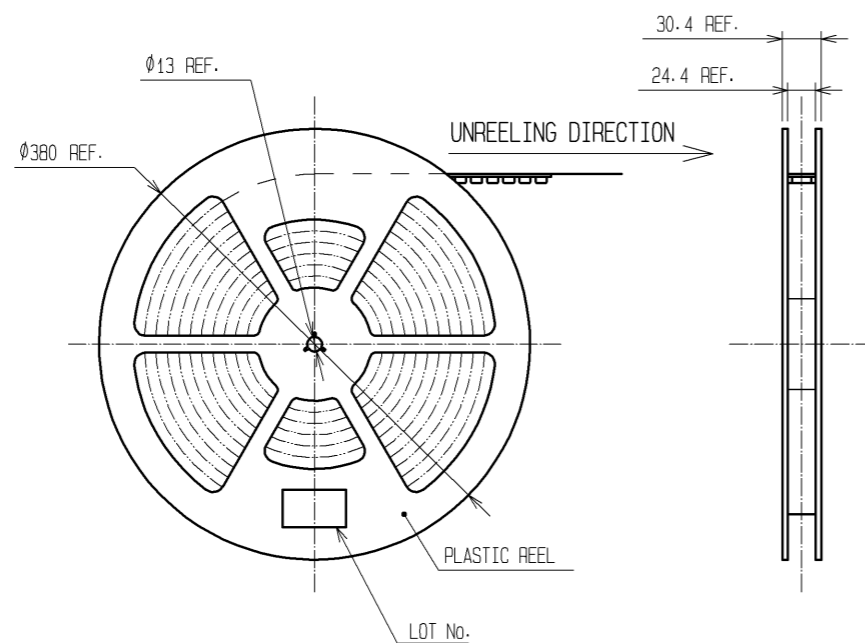
5	PE						
4	PS						
3	STAINLESS STEEL	OVER PLATING : TIN 1 µm min. LUBRICANT					
2	COPPER ALLOY						
1	LCP	BLACK, UL94V-0					
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS		
UNITS	mm	SCALE	5 : 1	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED
				APPROVED : NF. MIYAZAKI 08.08.01		DRAWING NO. EDC3-126332-05	
				CHECKED : TA. ASO 08.08.01		PART NO. ZX62-B-5PA(11)	
				DESIGNED : KO. KAWAMURA 08.07.31		CODE NO. CL242-0033-8-11	
				DRAWN : KO. KAWAMURA 08.07.31			

3 DRAWING FOR PACKING



7 FIG. 1 LOT CODE CONFIGURATION FOR 4 DIGITS

YEAR		MONTH		DAY				LINE No.			
YEAR	CODE	MONTH	CODE	DAY	CODE	DAY	CODE	DAY	CODE	LINE No.	CODE
2007	7	Jan.	A	1	1	11	B	21	M	1	A
2008	8	Feb.	B	2	2	12	C	22	N	2	B
2009	9	Mar.	C	3	3	13	D	23	P	3	C
2010	0	Apr.	D	4	4	14	E	24	Q	4	D
2011	1	May.	E	5	5	15	F	25	R	5	E
		Jun.	F	6	6	16	G	26	S	6	F
		Jul.	G	7	7	17	H	27	T	7	G
		Aug.	H	8	8	18	J	28	U	8	H
		Sep.	I	9	9	19	K	29	V	9	I
		Oct.	J	10	A	20	L	30	W	10	J
		Nov.	K					31	X	11	K
		Dec.	L								



<b>HRS</b>	DRAWING NO.	EDC3-126332-05
	PART NO.	ZX62-B-5PA(11)
	CODE NO.	CL242-0033-8-11
		△ 2/2